

Specification

MATERIAL:

Insulator: High Temperature Thermoplastic,
Color Black ,UL 94V-0.
Contact: Copper Alloy
Shell: Stainless Steel

PLATING:

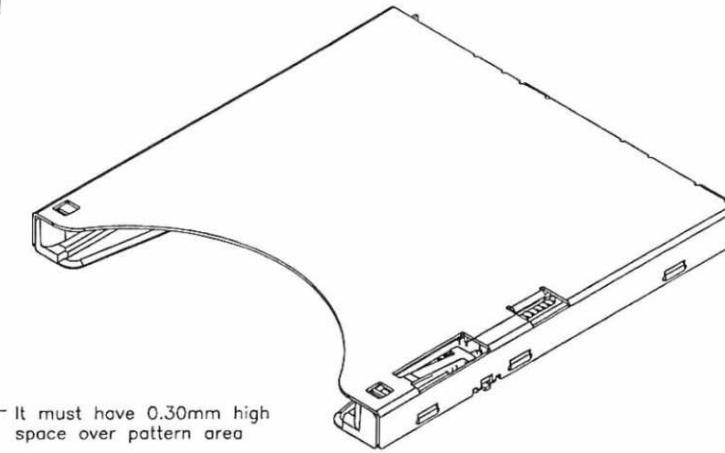
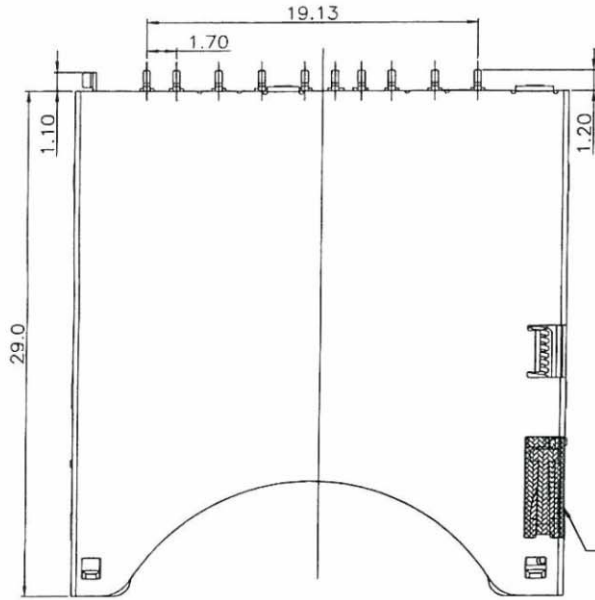
Contact: Plated 50u" Ni Overall
Plated Au Selective Contact Area
Plated 100u" Sn Over Ni On Solder Area
Shell: Plated 50u" Ni Overall
Plated Au Selective Solder Area

Electrical:

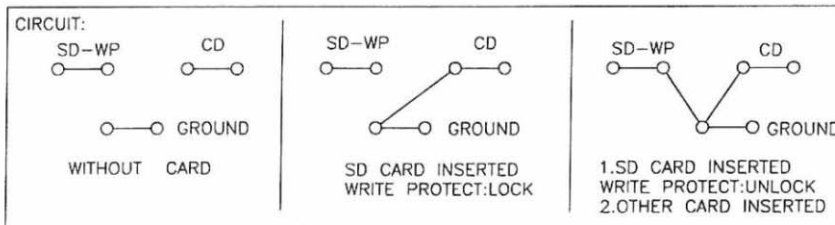
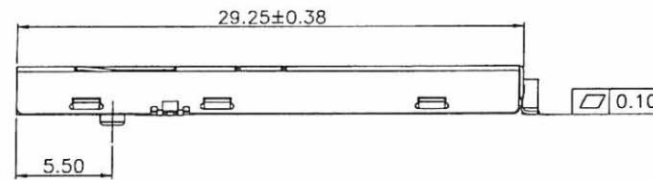
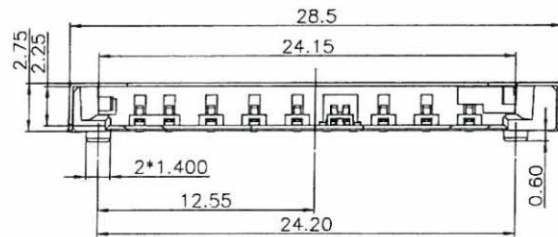
Current Rating :0.5mA max.
Contact Resistance:100mΩ max.
Insulation Resistance:1000MΩ min./500VDC
Dielectric Withstanding Voltage:500VAC/1 minute
Operating Temperature:-25°C TO+85°C
Mating Cycles:6,000 Insertions

Usable Memory Card:

SD&MMC Card



It must have 0.30mm high space over pattern area



RoHS Compliant

TOLERANCES ARE

MORETHANALL
PCB CONNECTORS
Cable ASSEMBLIES

煜倫股份有限公司

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DRAWING BY CY

CHECKED BY GENIUS

UNIT / mm

SCALE 1 : 1

DATE

SIZE A4

PPOJECTION

X, ±
.X ±
.XX ±
.XXX ±
ANG ±

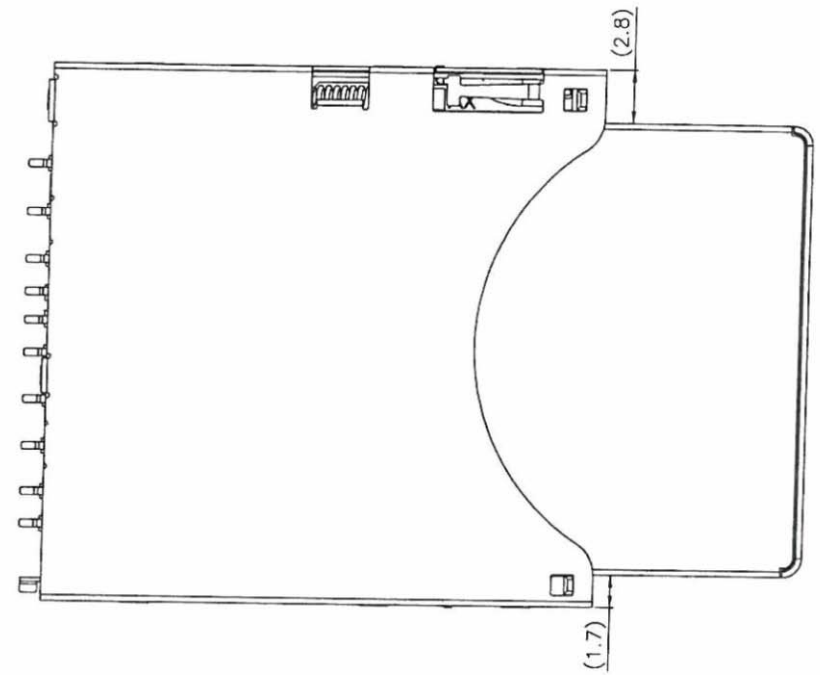
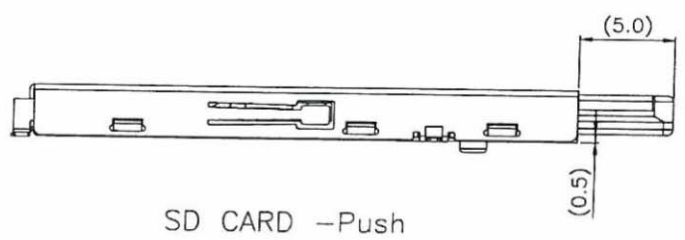
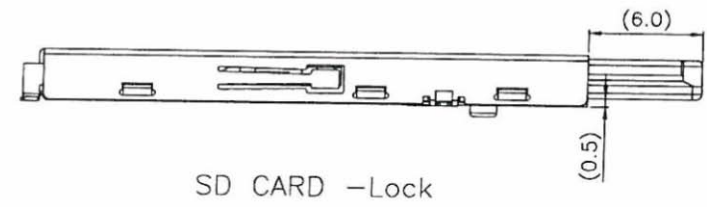
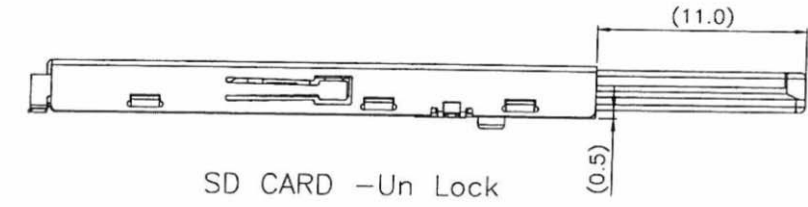


ORDER INFORMATION

SDC-W24PB02-09-LF
SERIES | | | | LEADFREE
| | | | 09WAY
| | | | PAD 0+2
| | | | B TYPE
90°SMT | | | | PUSH PUSH
| | | | POST TO POST 24.2mm

DESCRIPTION:

SD CARD INSERT DRAWIGN:



RoHS Compliant

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Cable ASSEMBLIES

DRAWING BY CY

CHECKED BY GENIUS

UNIT / mm

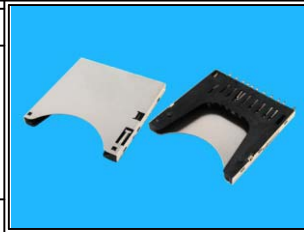
SCALE 1 : 1

DATE

SIZE A4

X, ±
.X ±
.XX ±
.XXX ±
ANG ±

PPOJECTION



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DESCRIPTION: